



S/N 10/721,722

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael O'Connor et al.

Examiner: Michael M. Trinh

Serial No.: 10/721,722

Group Art Unit: 2822

Filed: November 25, 2003

Docket No.: 884.398US2

Title: DIAMOND HEAT SPREADING AND COOLING
TECHNIQUE FOR INTEGRATED CIRCUITS

Assignee: Intel Corporation

Customer Number: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This responds to the Office Action mailed on July 1, 2005. Please amend the above-identified patent application as follows.